



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Is Now Part of



**ON Semiconductor®**

To learn more about ON Semiconductor, please visit our website at

[www.onsemi.com](http://www.onsemi.com)

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

# FXL2SD106

## Low-Voltage Dual-Supply 6-Bit Voltage Translator with Auto-Direction Sensing

### Features

- Bi-Directional Interface between Two Levels: 1.1V and 3.6V
- Fully Configurable: Inputs and Outputs Track  $V_{CC}$  Level
- Non-Preferential Power-up; Either  $V_{CC}$  May Be Powered-up First
- Outputs Remain in 3-State until Active  $V_{CC}$  Level is Reached
- Outputs Switch to 3-State if Either  $V_{CC}$  is at GND
- Power-Off Protection
- Bus hold on Data Inputs Eliminates Need for Pull-up Resistors (Do NOT Use Resistors on the A or B Ports)
- OE and CLK IN are Referenced to  $V_{CCA}$  Voltage
- Packaged in 16-Terminal DQFN (2.5mm x 3.5mm)
- Direction Control Not Needed
- 80 Mbps Throughput Translating between 1.8V and 2.5V
- ESD Protection Exceeds:
  - 12kV HBM (B port I/O to GND)  
(per JESD22-A114 & Mil Std 883e 3015.7)
  - 8kV HBM (A port I/O to GND)  
(per JESD22-A114 & Mil Std 883e 3015.7)
  - 1kV CDM (per ESD STM 5.3)

### General Description

The FXL2SD106 is a configurable dual-voltage-supply translator designed for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6V to as low as 1.1V. The A port tracks the  $V_{CCA}$  level and the B port tracks the  $V_{CCB}$  level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V.

The device remains in 3-state until both  $V_{CC}$  reach active levels, allowing either  $V_{CC}$  to be powered-up first. Internal power-down control circuits place the device in 3-state if either  $V_{CC}$  is removed.

The OE input, when low, disables both A and B ports by placing them in a 3-state condition. The FXL2SD106 is designed so that OE and CLK IN are supplied by  $V_{CCA}$ .

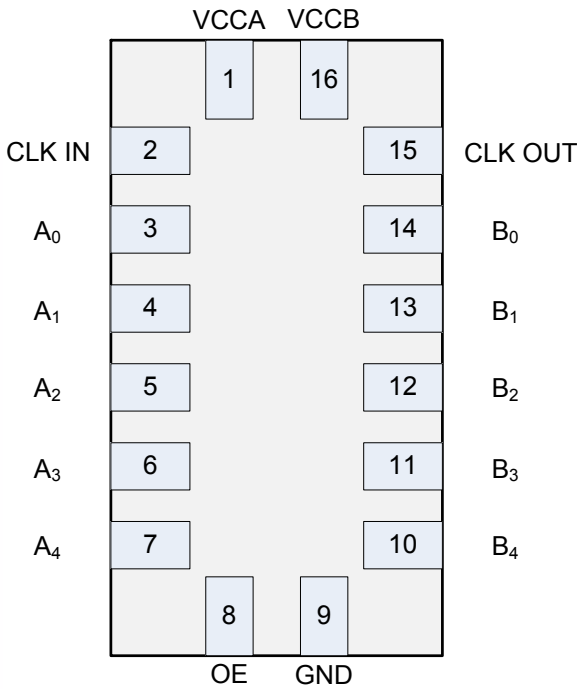
The device senses an input signal on A or B port automatically. The input signal is transferred to the other port.

The FXL2SD106 is not designed for SD card applications. The internal bus hold circuitry conflicts with pull-up resistors. SD cards have internal pull-up resistors on the CD/DAT3 pins.

### Ordering Information

Order Number	Package Number	Package Description
FXL2SD106BQX	MLP16E	16-Terminal Depopulated Quad Very-Thin Flat Pack, No Leads (DQFN), JEDEC MO-241, 2.5mm x 3.5mm

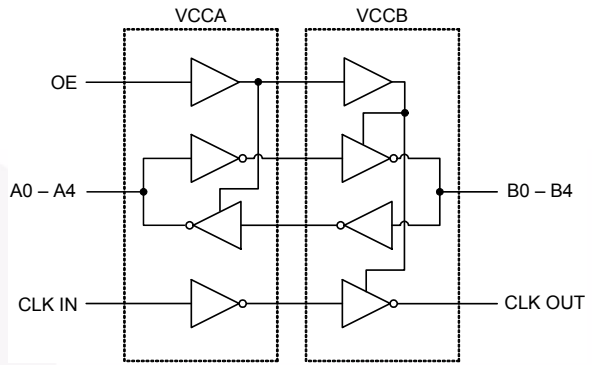
### Connection Diagram



### Pin Description

Number	Name	Description
1	V <sub>CCA</sub>	A-Side Power Supply
2	CLK IN	A-Side Input
3–7	A <sub>0</sub> –A <sub>4</sub>	A-Side Inputs or 3-State Outputs
8	OE	Output Enable Input
9	GND	Ground
10–14	B <sub>4</sub> –B <sub>0</sub>	B-Side Inputs or 3-State Outputs
15	CLK OUT	3-State Output
16	V <sub>CCB</sub>	B-Side Power Supply

### Functional Diagram



### Function Table

Control	Outputs
OE	
LOW Logic Level	3-State
HIGH Logic Level	Normal Operation

### Power-Up/Power-Down Sequencing

FXL translators offer an advantage in that either V<sub>CC</sub> may be powered up first. This benefit derives from the chip design. When either V<sub>CC</sub> is at 0 volts, outputs are in a high-impedance state. The control input (OE) is designed to track the V<sub>CCA</sub> supply. A pull-down resistor tying OE to GND should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up / power-down. The size of the pull-down resistor is based upon the current-sinking capability of the device driving the OE pin.

The recommended power-up sequence is the following:

1. Apply power to the first V<sub>CC</sub>.
2. Apply power to the second V<sub>CC</sub>.
3. Drive the OE input high to enable the device.

The recommended power-down sequence is the following:

1. Drive OE input low to disable the device.
2. Remove power from either V<sub>CC</sub>.
3. Remove power from other V<sub>CC</sub>.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
$V_{CCA}, V_{CCB}$	Supply Voltage	-0.5V to +4.6V
$V_I$	DC Input Voltage	-0.5V to +4.6V
	I/O Port A	-0.5V to +4.6V
	I/O Port B	-0.5V to +4.6V
	OE, CLK IN	-0.5V to +4.6V
$V_O$	Output Voltage <sup>(1)</sup>	-0.5V to +4.6V
	Outputs 3-STATE	-0.5V to $V_{CCA} + 0.5V$
	Outputs Active ( $A_n$ ) Outputs Active ( $B_n$ , CLK OUT)	-0.5V to $V_{CCB} + 0.5V$
$I_{IK}$	DC Input Diode Current at $V_I < 0V$	-50mA
$I_{OK}$	DC Output Diode Current at	
	$V_O < 0V$ $V_O > V_{CC}$	-50mA +50mA
$I_{OH}/I_{OL}$	DC Output Source/Sink Current	-50mA / +50mA
$I_{CC}$	DC $V_{CC}$ or Ground Current per Supply Pin	±100mA
$T_{STG}$	Storage Temperature Range	-65°C to +150°C

**Note:**

- $I_O$  Absolute Maximum Rating must be observed.

## Recommended Operating Conditions<sup>(2)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
$V_{CCA}$ or $V_{CCB}$	Power Supply Operating	1.1V to 3.6V
	Input Voltage	
	Port A	0.0V to 3.6V
	Port B	0.0V to 3.6V
	OE, CLK IN	0.0V to $V_{CCA}$
	Dynamic Output Current in $I_{OH}/I_{OL}$ with $V_{CC}$ at	
	3.0V to 3.6V	±18.0mA
	2.3V to 2.7V	±11.8mA
	1.65V to 1.95V	±7.4mA
	1.4V to 1.65V	±5.0mA
	1.1V to 1.4V	±2.6mA
	Static Output Current $I_{OH}/I_{OL}$ with $V_{CC}$ at 1.1V to 3.6V	±20.0µA
$T_A$	Free Air Operating Temperature	-40°C to +85°C
$\Delta t/\Delta V$	Maximum Input Edge Rate $V_{CCA/B} = 1.1V$ to 3.6V	10ns/V

**Note:**

- All unused inputs and I/O pins must be held at  $V_{CCI}$  or GND.

**DC Electrical Characteristics** ( $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ )

Symbol	Parameter	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Conditions	Min.	Typ.	Max.	Units
V <sub>IH</sub>	High Level Input Voltage	1.4–3.6	1.1–3.6	Data inputs A <sub>n</sub> , CLK IN, OE	0.6 x V <sub>CCA</sub>			V
		1.1–1.4	1.1–3.6		0.9 x V <sub>CCA</sub>			
		1.1–3.6	1.4–3.6	Data inputs B <sub>n</sub>	0.6 x V <sub>CCB</sub>			
		1.1–3.6	1.1–1.4		0.9 x V <sub>CCB</sub>			
V <sub>IL</sub>	Low Level Input Voltage	1.4–3.6	1.1–3.6	Data inputs A <sub>n</sub> , CLK IN, OE			0.35 x V <sub>CCA</sub>	V
		1.1–1.4	1.1–3.6				0.1 x V <sub>CCA</sub>	
		1.1–3.6	1.4–3.6	Data inputs B <sub>n</sub>			0.35 x V <sub>CCB</sub>	
		1.1–3.6	1.1–1.4				0.1 x V <sub>CCB</sub>	
V <sub>OH</sub> <sup>(3)</sup>	High Level Output Voltage	1.65–3.6	1.1–3.6	Data outputs A <sub>n</sub> , I <sub>HOLD</sub> = -20μA	0.75 x V <sub>CCA</sub>			V
		1.1–1.4	1.1–3.6			0.8		
		1.1–3.6	1.65–3.6	Data outputs B <sub>n</sub> , I <sub>HOLD</sub> = -20μA	0.75 x V <sub>CCB</sub>			
		1.1–3.6	1.1–1.4			0.8		
V <sub>OL</sub> <sup>(3)</sup>	Low Level Output Voltage	1.65–3.6	1.1–3.6	Data outputs A <sub>n</sub> , I <sub>HOLD</sub> = 20μA			0.2 x V <sub>CCA</sub>	V
		1.1–1.4	1.1–3.6			0.3		
		1.1–3.6	1.65–3.6	Data outputs B <sub>n</sub> , I <sub>HOLD</sub> = 20μA			0.2 x V <sub>CCB</sub>	
		1.1–3.6	1.1–1.4			0.3		
I <sub>I(ODH)</sub> <sup>(4)</sup>	Bushold Input Overdrive High Current	3.6	3.6	Data inputs A <sub>n</sub> , B <sub>n</sub>	450			μA
		2.7	2.7		300			
		1.95	1.95		200			
		1.6	1.6		120			
		1.4	1.4		80			
I <sub>I(ODL)</sub> <sup>(5)</sup>	Bushold Input Overdrive Low Current	3.6	3.6	Data inputs A <sub>n</sub> , B <sub>n</sub>	-450			μA
		2.7	2.7		-300			
		1.95	1.95		-200			
		1.6	1.6		-120			
		1.4	1.4		-80			
I <sub>I</sub>	Input Leakage Current	1.1–3.6	3.6	OE, CLK IN, V <sub>I</sub> = V <sub>CCA</sub> or GND			±1.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	0	3.6	A <sub>n</sub> , V <sub>O</sub> = 0V to 3.6V			±2.0	μA
		3.6	0	B <sub>n</sub> , CLK OUT, V <sub>O</sub> = 0V to 3.6V			±2.0	
I <sub>OZ</sub> <sup>(6)</sup>	3-State Output Leakage	3.6	3.6	A <sub>n</sub> , B <sub>n</sub> , CLK OUT, V <sub>O</sub> = 0V or 3.6V, OE = V <sub>IL</sub>			±2.0	μA
		3.6	0	A <sub>n</sub> , V <sub>O</sub> = 0V or 3.6V, OE = Don't Care			±2.0	
		0	3.6	B <sub>n</sub> , CLK OUT, V <sub>O</sub> = 0V or 3.6V, OE = Don't Care			±2.0	
I <sub>CCA/B</sub> <sup>(7)(8)</sup>	Quiescent Supply Current	1.1–3.6	1.1–3.6	V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0			5.0	μA
I <sub>CCZ</sub> <sup>(7)</sup>	Quiescent Supply Current	1.1–3.6	1.1–3.6	V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0, OE = V <sub>IL</sub>			5.0	μA
I <sub>CCA</sub> <sup>(7)</sup>	Quiescent Supply Current	0	1.1–3.6	V <sub>I</sub> = V <sub>CCB</sub> or GND; I <sub>O</sub> = 0			-2.0	μA
		1.1–3.6	0	V <sub>I</sub> = V <sub>CCA</sub> or GND; I <sub>O</sub> = 0			2.0	

### DC Electrical Characteristics ( $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ ) (Continued)

Symbol	Parameter	$V_{CCA}$ (V)	$V_{CCB}$ (V)	Conditions	Min.	Typ.	Max.	Units
$I_{CCB}^{(7)}$	Quiescent Supply Current	1.1–3.6	0	$V_I = V_{CCB}$ or GND; $I_O = 0$			-2.0	$\mu\text{A}$
		0	1.1–3.6	$V_I = V_{CCA}$ or GND; $I_O = 0$			2.0	

**Notes:**

- This is the output voltage for static conditions. Dynamic drive specifications are given in “Dynamic Output Electrical Characteristics.”
- An external driver must source at least the specified current to switch LOW-to-HIGH.
- An external driver must source at least the specified current to switch HIGH-to-LOW.
- “Don’t Care” indicates any valid logic level.
- $V_{CCI}$  is the  $V_{CC}$  associated with the input side.
- Reflects current per supply,  $V_{CCA}$  or  $V_{CCB}$ .

### Dynamic Output Electrical Characteristics<sup>(9)</sup>

**A Port ( $A_n$ )**

Output Load:  $C_L = 15\text{pF}$ ,  $R_L > 1\text{M}\Omega$

Symbol	Parameter	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CCA} =$									Units
		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		1.4V to 1.6V		1.1V to 1.3V	
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	
$t_{\text{rise}}^{(10)}$	Output Rise Time A Port		3.0		3.5		4.0		5.0	7.5	ns
$t_{\text{fall}}^{(11)}$	Output Fall Time A Port		3.0		3.5		4.0		5.0	7.5	ns
$I_{\text{OHD}}^{(10)}$	Dynamic Output Current High	-18.0		-11.8		-7.4		-5.0		-2.6	mA
$I_{\text{OLD}}^{(11)}$	Dynamic Output Current Low	+18.0		+11.8		+7.4		+5.0		+2.6	mA

**B Port ( $B_n$ , CLK OUT)**

Output Load:  $C_L = 15\text{pF}$ ,  $R_L > 1\text{M}\Omega$

Symbol	Parameter	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CCB} =$									Units
		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		1.4V to 1.6V		1.1V to 1.3V	
		Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	
$t_{\text{rise}}^{(10)}$	Output Rise Time B Port		3.0		3.5		4.0		5.0	7.5	ns
$t_{\text{fall}}^{(11)}$	Output Fall Time B Port		3.0		3.5		4.0		5.0	7.5	ns
$I_{\text{OHD}}^{(10)}$	Dynamic Output Current High	-18.0		-11.8		-7.4		-5.0		-2.6	mA
$I_{\text{OLD}}^{(11)}$	Dynamic Output Current Low	+18.0		+11.8		+7.4		+5.0		+2.6	mA

**Notes:**

- Dynamic Output Characteristics are guaranteed, but not tested.
- See Figure 5.
- See Figure 6.

## AC Characteristics

$V_{CCA} = 3.0V$  to  $3.6V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.2	3.5	0.3	3.9	0.5	5.4	0.6	6.8	22.0	ns
	B to A	0.2	3.5	0.2	3.8	0.3	5.0	0.5	6.0	15.0	ns
$t_{PLH}$ , $t_{PHL}$	CLK IN to CLK OUT		3.0		3.5		4.5		6.0	15.0	ns
$t_{PZL}$ , $t_{PZH}$	OE to A, OE to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(12)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 2.3V$  to  $2.7V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.2	3.8	0.4	4.2	0.5	5.6	0.8	6.9	22.0	ns
	B to A	0.3	3.9	0.4	4.2	0.5	5.5	0.5	6.5	15.0	ns
$t_{PLH}$ , $t_{PHL}$	CLK IN to CLK OUT		3.5		4.0		4.5		6.5	15.0	ns
$t_{PZL}$ , $t_{PZH}$	OE to A, OE to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(12)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 1.65V$  to  $1.95V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.3	5.0	0.5	5.5	0.8	6.7	0.9	7.5	22.0	ns
	B to A	0.5	5.4	0.5	5.6	0.8	6.7	1.0	7.0	15.0	ns
$t_{PLH}$ , $t_{PHL}$	CLK IN to CLK OUT		4.5		4.5		6.3		6.7	15.0	ns
$t_{PZL}$ , $t_{PZH}$	OE to A, OE to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(12)}$	A Port, B Port		0.5		0.5		0.5		1.0	1.0	ns

$V_{CCA} = 1.4V$  to  $1.6V$

Symbol	Parameter	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , $V_{CCB} =$									Units
		3.0V–3.6V		2.3V–2.7V		1.65V–1.95V		1.4V–1.6V		1.1V–1.3V	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Typ.	
$t_{PLH}$ , $t_{PHL}$	A to B	0.5	6.0	0.5	6.5	1.0	7.0	1.0	8.5	22.0	ns
	B to A	0.6	6.8	0.8	6.9	0.9	7.5	1.0	8.5	15.0	ns
$t_{PLH}$ , $t_{PHL}$	CLK IN to CLK OUT		6.0		6.5		6.7		8.5	15.0	ns
$t_{PZL}$ , $t_{PZH}$	OE to A, OE to B		1.7		1.7		1.7		1.7	1.7	$\mu s$
$t_{skew}^{(12)}$	A Port, B Port		1.0		1.0		1.0		1.0	1.0	ns

**Note:**

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port ( $A_n$  or  $B_n$ ) and switching with the same polarity (Low-to-High or High-to-Low). See Figure 8.



### Maximum Data Rate<sup>(13)(14)</sup>

$V_{CCA}$	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C, } V_{CCB} =$					Units
	3.0V to 3.6V	2.3V to 2.7V	1.65V to 1.95V	1.4V to 1.6V	1.1V to 1.3V	
	Min.	Min.	Min.	Min.	Typ.	
$V_{CCA} = 3.0\text{V to } 3.6\text{V}$	100	100	80	60	20	Mbps
$V_{CCA} = 2.3\text{V to } 2.7\text{V}$	100	100	80	60	20	Mbps
$V_{CCA} = 1.65\text{V to } 1.95\text{V}$	80	80	60	40	20	Mbps
$V_{CCA} = 1.4\text{V to } 1.6\text{V}$	60	60	40	40	20	Mbps
	Typ.	Typ.	Typ.	Typ.	Typ.	
$V_{CCA} = 1.1\text{V to } 1.3\text{V}$	20	20	20	20	20	Mbps

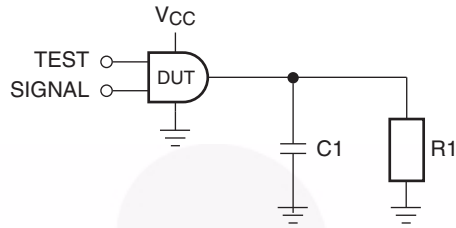
**Note:**

13. Maximum data rate is guaranteed but not tested.

14. Maximum data rate is specified in megabits per second. See Figure 7. It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100 Mbps is equivalent to 50 MHz.

### Capacitance

Symbol	Parameter	Conditions	$T_A = +25^{\circ}\text{C}$	Units	
			Typical		
$C_{IN}$	Input Capacitance, OE, CLK IN	$V_{CCA} = V_{CCB} = \text{GND}$	4	pF	
$C_{I/O}$	Input/Output Capacitance	$A_n$	$V_{CCA} = V_{CCB} = 3.3\text{V,}$ $\text{OE} = V_{CCA}$	5	pF
		$B_n, \text{CLK OUT}$		6	
$C_{PD}$	Power Dissipation Capacitance	$V_{CCA} = V_{CCB} = 3.3\text{V,}$ $V_i = 0\text{V or } V_{CC}, f = 10\text{MHz}$	25	pF	

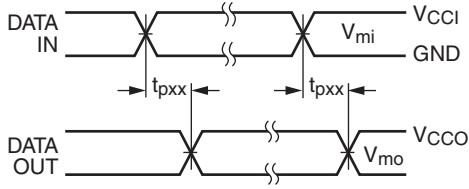


Test	Input Signal	Output Enable Control
$t_{PLH}$ , $t_{PHL}$	Data Pulses	$V_{CCA}$
$t_{PZL}$	0V	Low to High Switch
$t_{PZH}$	$V_{CCI}$	Low to High Switch

Figure 1. AC Test Circuit

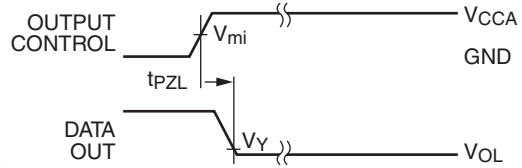
**AC Load Table**

$V_{CCO}$	CI	RI
$1.2V \pm 0.1V$	15pF	1M $\Omega$
$1.5V \pm 0.1V$	15pF	1M $\Omega$
$1.8V \pm 0.15V$	15pF	1M $\Omega$
$2.5V \pm 0.2V$	15pF	1M $\Omega$
$3.3 \pm 0.3V$	15pF	1M $\Omega$

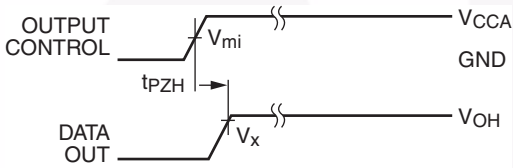


Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%  
 Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only

**Figure 2. Waveform for Inverting and Non-inverting Functions**



Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%  
 Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only  
**Figure 3. 3-STATE Output Low Enable Time for Low Voltage Logic**

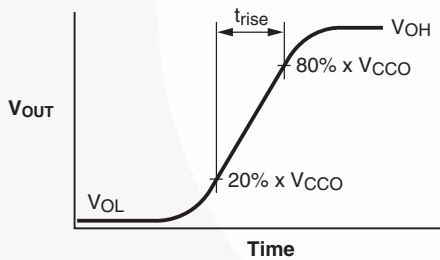


Input  $t_R = t_F = 2.0\text{ns}$ , 10% to 90%  
 Input  $t_R = t_F = 2.5\text{ns}$ , 10% to 90%, @  $V_i = 3.0\text{V}$  to  $3.6\text{V}$  only

**Figure 4. 3-STATE Output High Enable Time for Low Voltage Logic**

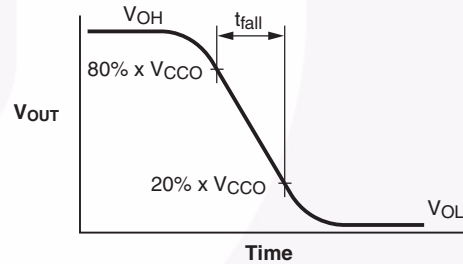
Symbol	Vcc
$V_{mi}^{(15)}$	$V_{CCI} / 2$
$V_{mo}$	$V_{CCO} / 2$
$V_X$	$0.9 \times V_{CCO}$
$V_Y$	$0.1 \times V_{CCO}$

**Note:**  
 15.  $V_{CCI} = V_{CCA}$  for control pin OE or  $V_{mi} = (V_{CCA} / 2)$ .



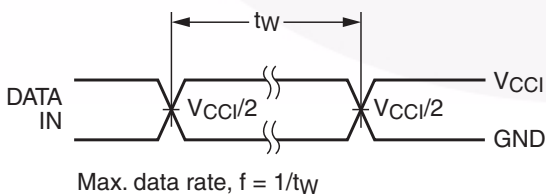
$$I_{OHD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(20\% - 80\%) \times V_{CCO}}{t_{RISE}}$$

**Figure 5. Active Output Rise Time and Dynamic Output Current High**

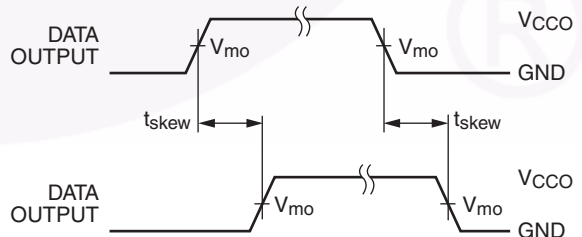


$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \times V_{CCO}}{t_{FALL}}$$

**Figure 6. Active Output Fall Time and Dynamic Output Current Low**



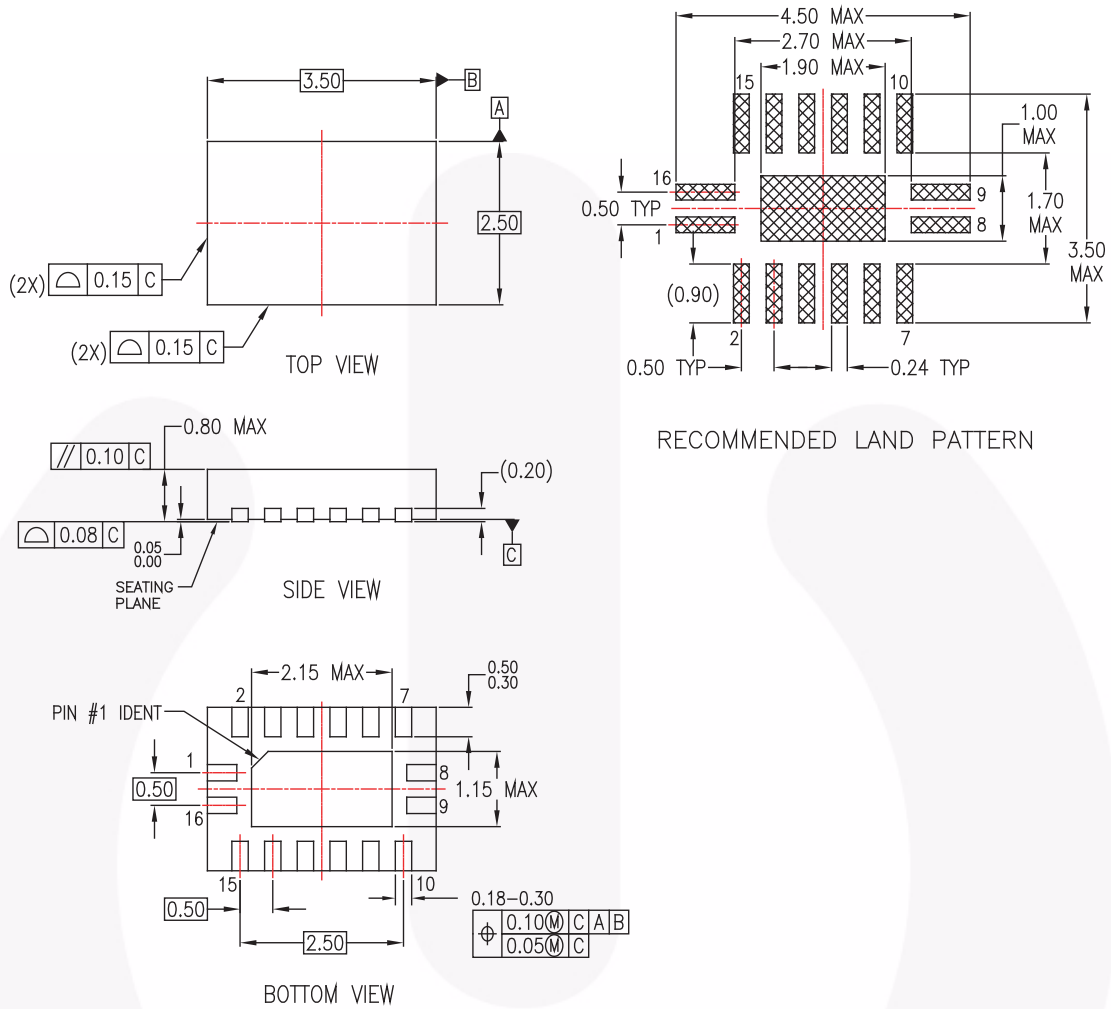
**Figure 7. Maximum Data Rate**



$$t_{skew} = (t_{pHLmax} - t_{pHLmin}) \text{ or } (t_{pLHmax} - t_{pLHmin})$$

**Figure 8. Output Skew Time**

## Physical Dimensions



### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AB
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP16ErevA

**Figure 9. 16-Terminal Depopulated Quad, Very-Thin Flat Pack, No Leads (DQFN), JEDEC MO-241 2.5mm x 3.5mm**

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>





For current tape and reel specifications, visit Fairchild Semiconductor's packaging area:

<http://www.fairchildsemi.com/ms/MS/MS-522.pdf>



**TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

- |   |   |   |   |
|---|---|---|---|
| 2Cool™  | FlashWriter®*   | PDP SPM™  | The Power Franchise®  |
| AccuPower™  | FPST™   | Power-SPM™  | The Right Technology for Your Success™  |
| Auto-SPM™   | F-PFS™  | PowerTrench®  | <b>the power franchise</b>  |
| AX-CAP™*  | FRFET®  | PowerXS™  | TinyBoost™  |
| BitSiC®   | Global Power Resource™  | Programmable Active Droop™  | TinyBuck™   |
| Build it Now™   | Green FPS™  | QFET®   | TinyCalc™   |
| CorePLUS™   | Green FPS™ e-Series™  | QST™  | TinyLogic®  |
| CorePOWER™  | Gmax™   | Quiet Series™   | TINYOPTO™   |
| CROSSVOLT™  | GTO™  | RapidConfigure™   | TinyPower™  |
| CTL™  | IntelliMAX™   |  | TinyPVM™  |
| Current Transfer Logic™   | ISOPLANAR™  | Saving our world, 1mW/W/kW at a time™   | TinyWire™   |
| DEUXPEED®   | MegaBuck™   | SignalWise™   | TranSiC®  |
| Dual Cool™  | MICROCOUPLER™   | SmartMax™   | TriFault Detect™  |
| EcoSPARK®   | MicroFET™   | SMART START™  | TRUECURRENT®*   |
| EfficientMax™   | MicroPak™   | SPM®  | µSerDes™  |
| ESBC™   | MicroPak2™  | STEALTH™  |  |
|  | MillerDrive™  | SuperFET®   | UHC®  |
| Fairchild®  | MotionMax™  | SuperSOT™.3   | Ultra FRFET™  |
| Fairchild Semiconductor®  | Motion-SPM™   | SuperSOT™.6   | UniFET™   |
| FACT Quiet Series™  | mWSaver™  | SuperSOT™.8   | VCX™  |
| FACT®   | OptoHi™   | SupreMOS®   | VisualMax™  |
| FAST®   | OPTOLOGIC®  | SyncFET™  | XS™   |
| FastvCore™  | OPTOPLANAR®   | Sync-Lock™  |   |
| FETBench™   |  |   |   |

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

**DISCLAIMER**

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

**LIFE SUPPORT POLICY**

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**ANTI-COUNTERFEITING POLICY**

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, [www.fairchildsemi.com](http://www.fairchildsemi.com), under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

**PRODUCT STATUS DEFINITIONS**

**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I55

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA  
**Phone:** 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada  
**Europe, Middle East and Africa Technical Support:**  
Phone: 421 33 790 2910  
**Japan Customer Focus Center**  
Phone: 81-3-5817-1050

**ON Semiconductor Website:** [www.onsemi.com](http://www.onsemi.com)  
**Order Literature:** <http://www.onsemi.com/orderlit>  
For additional information, please contact your local  
Sales Representative